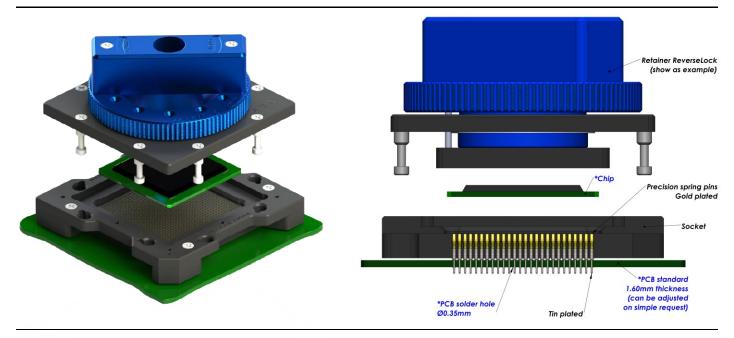
Through-hole (THT) soldering Test Socket

For LGA / QFN / MLF / MLP / LCC Package **0.50 mm pitch** (from 0.50 mm up to 0.79 mm)



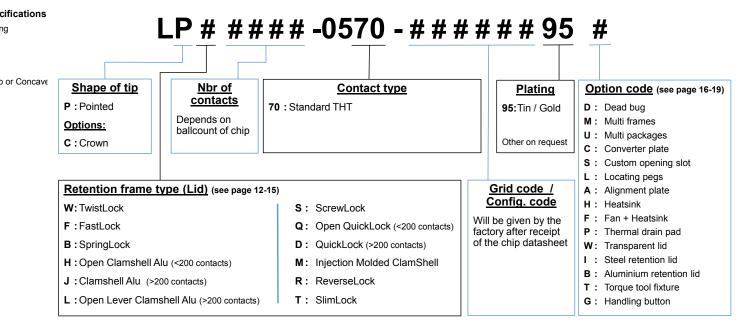


E-tec Interconnect AG is the world leading Test socket manufacturer

The Through-hole socket uses the same footprint as your chip. Socket is simply placed and wave soldered onto the PCB in the same way as the chip and it only requires a small amount of additional board space. Through-hole sockets are available with all retention systems. Please note, we will always request the chip data to ensure we offer a compatible socket.

Specifications contact type code 0570			
Application	Through-hole technology	Force	30 gr
Mounting	THT	Current rating	1 A
Bandwidth (GHz@-1dB)	2.7 GHz	Capacitance pF	< 1 pF
Contact resistance	<100mOhm	Inductance nH	< 2 nH
Chip contact tip shape	Single Point tip or Concave tip	Temperature range	-55°C to +150°C
PCB tip shape	Through-hole	Mating cycles	100 K

How to order





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